

L Number	Hits	Search Text	DB	Time stamp
1	33	451/\$.ccls. and spin adj glass	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/12/28 12:53
2	10	451/44 and hydrofluoric adj acid	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/12/28 12:53
3	214	451/\$.ccls. and hydrofluoric adj acid	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/12/28 12:54
4	276	(451/44).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/12/28 12:54
5	12	451/44 and hydrofluoric	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/12/28 12:54
6	402	451/44	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/12/28 12:54
7	151	451/44 and wafer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/12/28 12:54
-	28	451/\$.ccls. and spin adj glass	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/12/28 12:53
-	8	451/44 and hydrofluoric adj acid	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/12/28 12:53
-	198	451/\$.ccls. and hydrofluoric adj acid	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/12/28 12:53
-	135	(451/\$.ccls. and hydrofluoric adj acid) and wafer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/06/20 19:02
-	266	(451/44).CCLS.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/12/28 12:54
-	10	451/44 and hydrofluoric	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/12/28 12:54
-	384	451/44	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM TDB	2003/12/28 12:54

-	138	451/44 and wafer	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/28 12:54
-	86	(spin adj glass) near4 (remov\$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/22 21:13
-	67	(spin adj glass) near4 (grind\$3 or polish\$)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/22 21:16
-	14	edge adj bead near4 (grind\$3 or polish\$)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2003/12/22 21:16